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VS-GB90DA120U



Vishay Semiconductors

Insulated Gate Bipolar Transistor (Ultrafast IGBT), 90 A



PRODUCT SUMMARY						
V _{CES}	1200 V					
I _C DC	90 A at 90 °C					
V _{CE(on)} typical at 75 A, 25 °C	3.3 V					
Speed	8 kHz to 30 kHz					
Package	SOT-227					
Circuit	Single switch diode					

FEATURES

- NPT Gen 5 IGBT technology
- Square RBSOA
- HEXFRED[®] low Q_{rr}, low switching energy
- Positive V_{CE(on)} temperature coefficient
- · Fully isolated package
- Very low internal inductance (≤ 5 nH typical)
- · Industry standard outline
- UL approved file E78996
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- · Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- Direct mounting on heatsink
- · Plug-in compatible with other SOT-227 packages
- · Low EMI, requires less snubbing

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Collector to emitter voltage	V _{CES}		1200	V		
Continuous collector current		$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	149			
Continuous collector current	IC (.)	T _C = 90 °C	90			
Pulsed collector current	I _{CM}		200			
Clamped inductive load current	I _{LM}		200	A		
Diode continuous forward current		$T_{C} = 25 \ ^{\circ}C$	76			
Diode continuous forward current	I _F	T _C = 90 °C	46	1		
Gate to emitter voltage	V _{GE}		± 20	V		
Dower discipation ICDT	D	T _C = 25 °C	862			
Power dissipation, IGBT	PD	$T_{\rm C} = 90 \ ^{\circ}{\rm C}$	414	w		
		$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	357	VV VV		
Power dissipation, diode	PD	T _C = 90 °C	171			
Isolation voltage	V _{ISOL}	Any terminal to case, t = 1 min	2500	V		

Note

(1) Maximum collector current admitted is 100 A, to do exceed the maximum temperature of terminals

1





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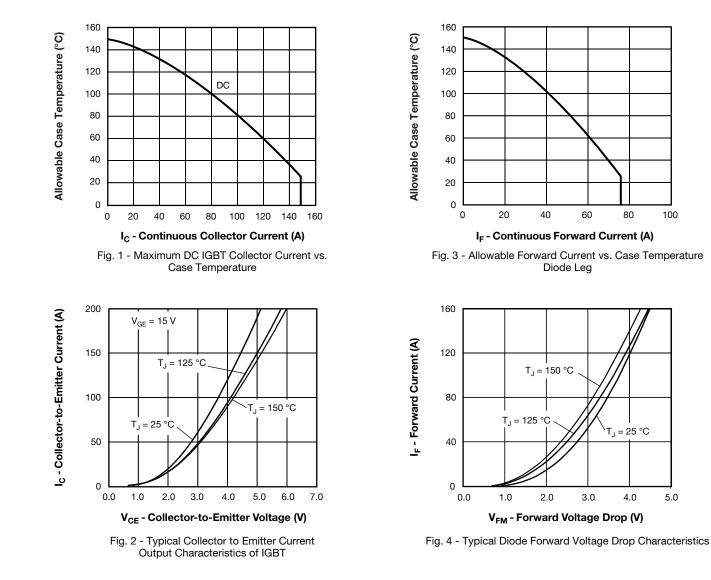
ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V _{BR(CES)}	V_{GE} = 0 V, I _C = 250 µA	1200	-	-		
		V _{GE} = 15 V, I _C = 75 A	-	3.3	3.8		
Collector to emitter voltage	V _{CE(on)}	V _{GE} = 15 V, I _C = 75 A, T _J = 125 °C	-	3.6	3.9	V	
		V _{GE} = 15 V, I _C = 75 A, T _J = 150 °C	-	3.7	-		
Cata threshold voltage	M	$V_{CE} = V_{GE}, I_C = 250 \ \mu A$	4	5	6		
Gate threshold voltage	V _{GE(th)}	V_{CE} = V_{GE} , I_C = 250 μ A, T_J = 125 °C	-	3.2	-		
Temperature coefficient of threshold voltage	$V_{GE(th)}/\Delta T_J$	V_{CE} = V_{GE} , I_C = 1 mA (25 °C to 125 °C)	-	-12	-	mV/°C	
		V _{GE} = 0 V, V _{CE} = 1200 V	-	7	250	μA	
Collector to emitter leakage current	I _{CES}	V_{GE} = 0 V, V_{CE} = 1200 V, T_{J} = 125 °C	-	1.4	10	mA	
		V_{GE} = 0 V, V_{CE} = 1200 V, T_{J} = 150 °C	-	6.5	20	- IIIA	
		$V_{GE} = 0 \text{ V}, I_F = 75 \text{ A}$	-	3.4	5.0		
Forward voltage drop, diode	V _{FM}	V_{GE} = 0 V, I _F = 75 A, T _J = 125 °C	-	3.2	5.2	V	
		$V_{GE} = 0 \text{ V}, \text{ I}_{F} = 75 \text{ A}, \text{ T}_{J} = 150 ^{\circ}\text{C}$	-	3.05	-		
Gate to emitter leakage current	I _{GES}	$V_{GE} = \pm 20 \text{ V}$	-	-	± 250	nA	

SWITCHING CHARACTERI	STICS (T _J	= 25 °C unless otherv	vise specified)				
PARAMETER	SYMBOL	TEST CONDIT	MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Qg			-	690	-	
Gate to emitter charge (turn-on)	Q _{ge}	I _C = 50 A, V _{CC} = 600 V, V _{GE} = 15 V		-	65	-	nC
Gate to collector charge (turn-on)	Q _{gc}		·	-	250	-	
Turn-on switching loss	E _{on}			-	1.2	-	
Turn-off switching loss	E _{off}			-	2.1	-	mJ
Total switching loss	E _{tot}	I _C = 75 A, V _{CC} = 600 V,		-	3.3	-	
Turn-on delay time	t _{d(on)}	$V_{GE} = 15 \text{ V}, \text{ R}_{a} = 5 \Omega,$		-	250	-	
Rise time	tr	L = 500 µH, T _J = 25 °C		-	38	-	- ns
Turn-off delay time	t _{d(off)}		Energy losses include tail and	-	280	-	
Fall time	t _f			-	90	-	
Turn-on switching loss	E _{on}		diode recovery Diode used HFA16PB120	-	1.7	-	mJ
Turn-off switching loss	E _{off}			-	4.08	-	
Total switching loss	E _{tot}	I_{C} = 75 A, V _{CC} = 600 V, V _{GE} = 15 V, R _g = 5 Ω,		-	5.78	-	
Turn-on delay time	t _{d(on)}			-	245	-	ns
Rise time	tr	L = 500 μH, Τ _J = 125 °C		-	48	-	
Turn-off delay time	t _{d(off)}			-	280	-	
Fall time	t _f			-	140	-	
Reverse bias safe operating area	RBSOA	T_J = 150 °C, I _C = 200 A, R _g = 22 Ω, V _{GE} = 15 V to 0 V, V _{CC} = 900 V, V _P = 1200 V, L = 500 μH			Fulls	quare	
Diode reverse recovery time	t _{rr}			-	140	-	ns
Diode peak reverse current	I _{rr}	I _F = 50 A, dI _F /dt = 200 A/µs, V _R = 200 V - 13				-	А
Diode recovery charge	Q _{rr}			-	860	-	nC
Diode reverse recovery time	t _{rr}			-	210	-	ns
Diode peak reverse current	I _{rr}	I _F = 50 A, dI _F /dt = 200 A/ T _{.1} = 125 °C	µs, V _R = 200 V,	-	19	-	А
Diode recovery charge	Q _{rr}	·J = 120 0	-	1880	-	nC	

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THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Junction and storage te	mperature range	T _J , T _{Stg}		-40	-	150	°C
Junction to case	IGBT	D		-	-	0.145	
Diode	R _{thJC}		-	-	0.35	°C/W	
Case to heatsink		R _{thCS}	Flat, greased surface	-	0.05	-	
Weight				-	30	-	g
Mounting torque			Torque to terminal	-	-	1.1 (9.7)	Nm (lbf.in)
Mounting torque	loidue		Torque to heatsink	-	-	1.3 (11.5)	Nm (lbf.in)
Case style			S	OT-227			



3

5.0

100

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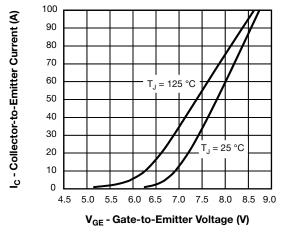


Fig. 5 - Typical IGBT Transfer Characteristics

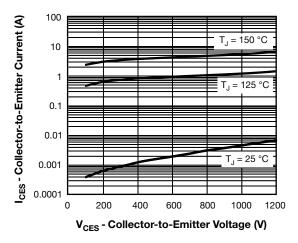


Fig. 6 - Typical IGBT Zero Gate Voltage Collector Current

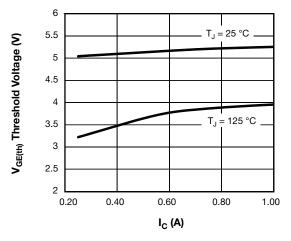


Fig. 7 - Typical IGBT Threshold Voltage

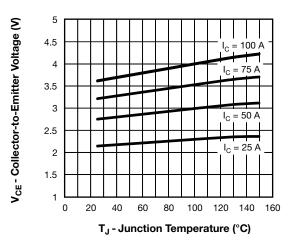


Fig. 8 - Typical IGBT Collector to Emitter Voltage vs. Junction Temperature, V_{GE} = 15 V

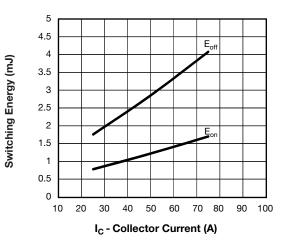


Fig. 9 - Typical IGBT Energy Losses vs. I_C T_J = 125 °C, L = 500 μ H, V_{CC} = 600 V, R_a = 5 Ω , V_{GE} = 15 V, Diode used HFA16PB120

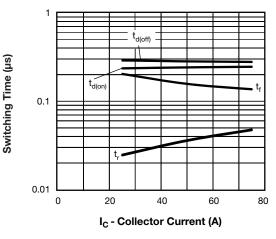


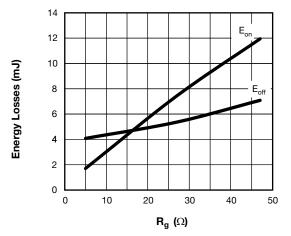
Fig. 10 - Typical IGBT Switching Time vs. I_C T_J = 125 °C, L = 500 µH, V_{CC} = 600 V, R_g = 5 Ω , V_{GE} = 15 V, Diode used HFA16PB120

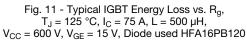
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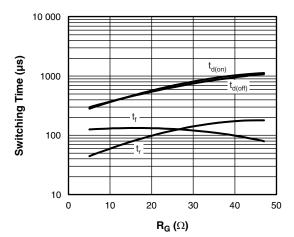


Fig. 12 - Typical IGBT Switching Time vs. R_g T_J = 125 °C, L = 500 $\mu H,$ V_{CC} = 600 V, R_g = 5 $\Omega,$ V_{GE} = 15 V

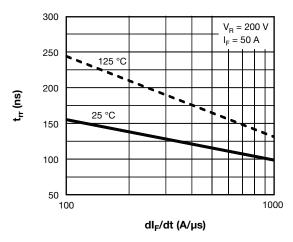
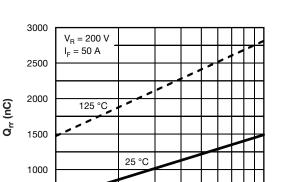


Fig. 13 - Typical t_{rr} Diode vs. dI_F/dt V_{RR} = 200 V, I_F = 50 A





500

100

Fig. 14 - Stored Charge vs. dl_F/dt of Diode

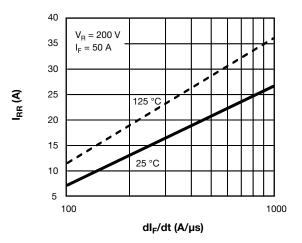


Fig. 15 - Typical Reverse Recovery Current vs. dl_F/dt of Diode

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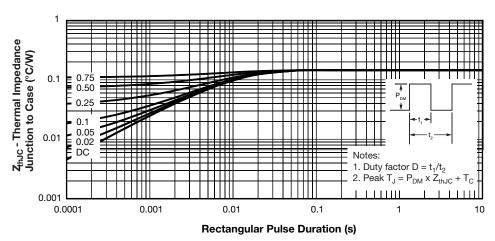
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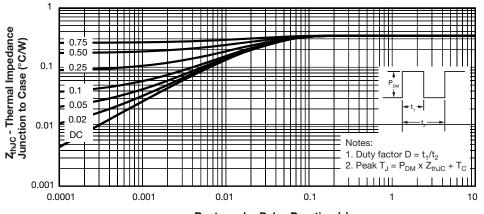
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Fig. 16 - Maximum Thermal Impedance ZthJC Characteristics (IGBT)



Rectangular Pulse Duration (s)

Fig. 17 - Maximum Thermal Impedance Z_{thJC} Characteristics (Diode)

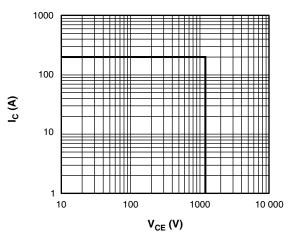
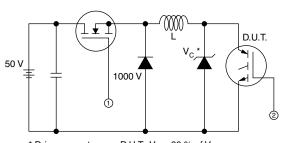


Fig. 18 - IGBT Reverse Bias SOA, TJ = 150 °C, V_{GE} = 15 V,

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SHA

* Driver same type as D.U.T.; V_C = 80 % of V_{ce(max.)} * Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain Id

Fig. 19a - Clamped Inductive Load Test Circuit

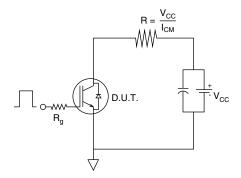


Fig. 19b - Pulsed Collector Current Test Circuit

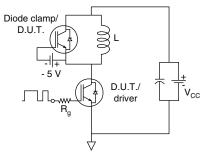


Fig. 20a - Switching Loss Test Circuit

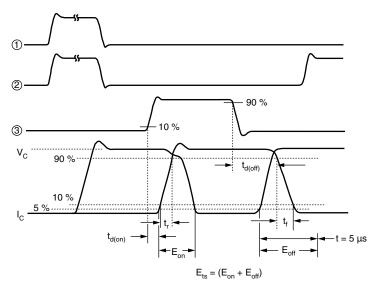


Fig. 20b - Switching Loss Waveforms Test Circuit



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ORDERING INFORMATION TABLE

Device code	VS-	G	В	90	D	Α	120	U
		2	3	4	5	6	7	8
	1	· Visl	nay Sen	niconduo	ctors pro	oduct		
	2	2 - Insulated Gate Bipolar Transistor (IGBT)						
	3	• В =	IGBT G	Generatio	on 5			
	4	- Cur	rent rati	ng (90 =	= 90 A)			
	5	- Circ	uit conf	iguratio	n (D = S	ingle sv	vitch wit	th antipa
	6	Pac	kage in	dicator (A = SO	T-227)		
	7	Vol	age rati	ing (120	= 1200	V)		
	8	- Spe	ed/type	(U = UI	trafast I	GBT)		

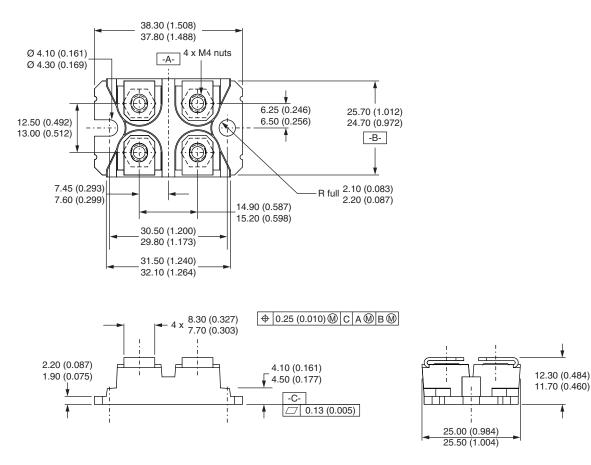
CIRCUIT CONFI	GURATION				
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING			
Single switch with antiparallel diode	D	2 (G) O Lead Assignment 1,4 (E)			

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95423				
Packaging information	www.vishay.com/doc?95425				



SOT-227 Generation II

DIMENSIONS in millimeters (inches)



Note

• Controlling dimension: millimeter



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